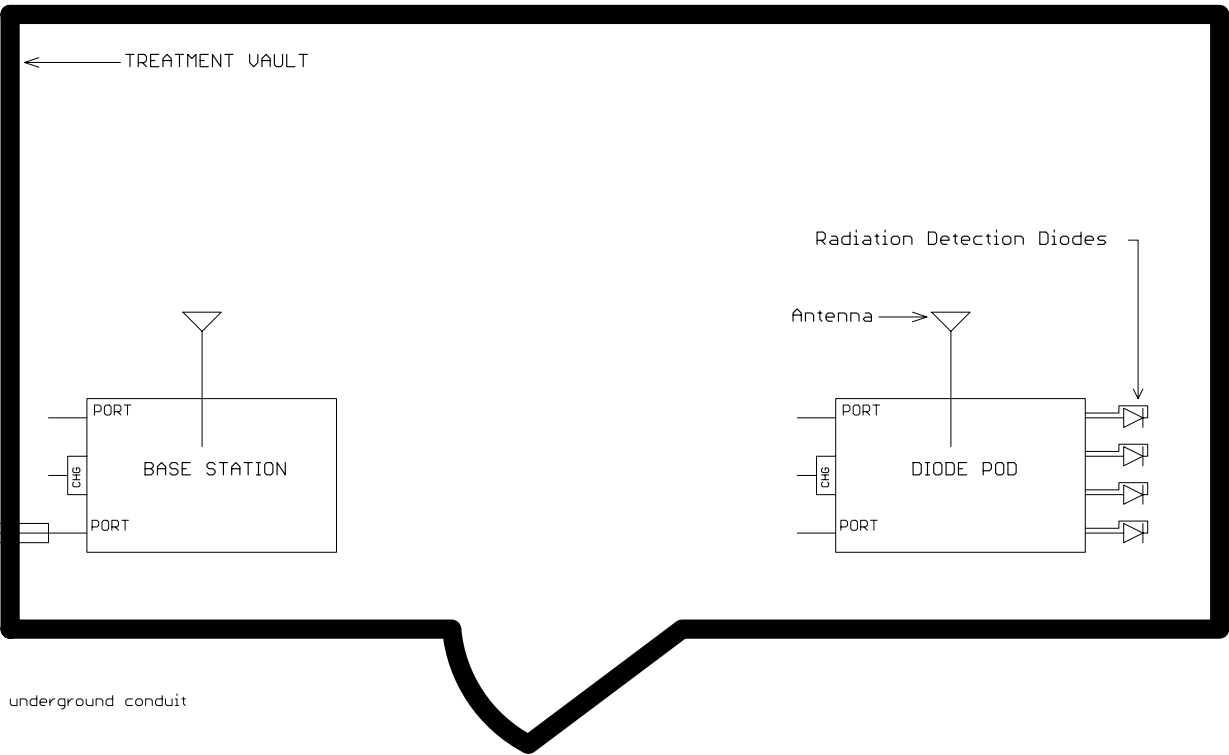
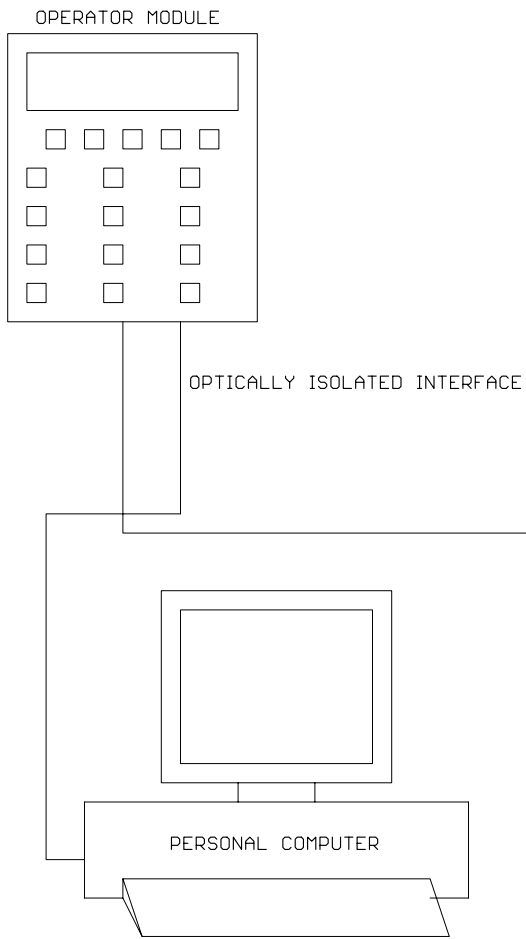
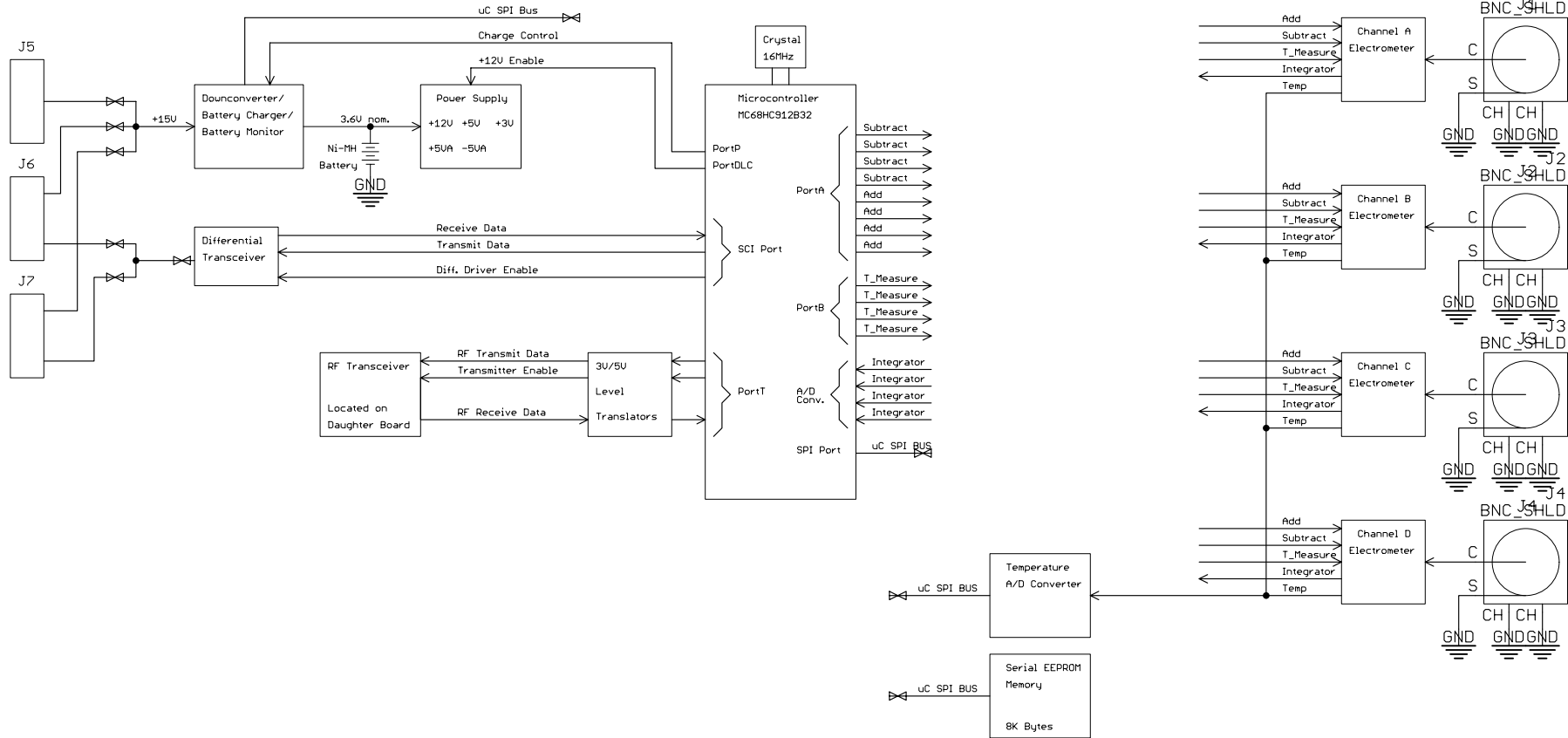




NOTES:

- 1) The treatment vault has 3.0 feet thick steel & concrete walls on all sides. The door is an 8 inch thick steel and boron-polycarbonate laminate. No radiation enters or leaves the room; whether it is electromagnetic or from subatomic particles.
- 2) The system may use a Personal Computer in addition to the Operator Module.
- 3) The Base Station & the Diode Pod have identical hardware & software.
- 4) The patients are treated with beams of particles from radioactive isotopes or from a particle accelerator within the treatment vault.
- 5) The radiation detection diodes are taped to a patient; however their contact is incidental.

	REV	DESCRIPTION	BY DATE
DRAWN BY R.E.Karl	SUN NUCLEAR CORPORATION 425-A PINEDA CT. MELBOURNE, FL 32940 (407) 259-6862		
CHECKED BY			
APPROVED			
	TITLE RF-IVD 2 BLOCK DIAGRAM SYSTEM LEVEL		
	SIZE A	DRAWING NO. 1136-BD-1	REV A
	SCALE	NONE	SHEET 1 OF 1

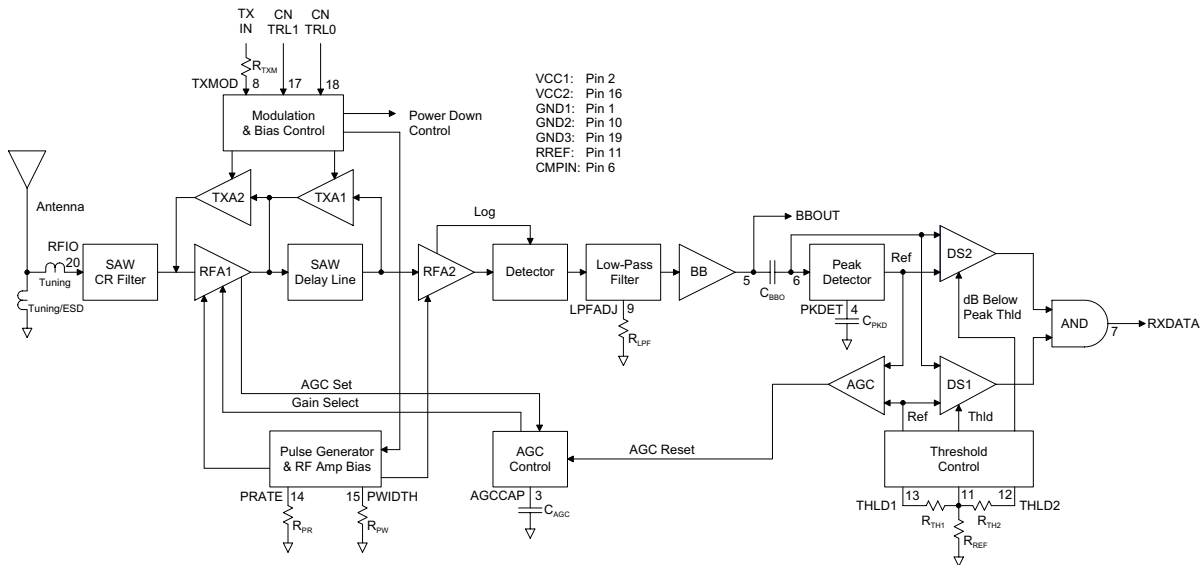


NOTES:

- 1) The PC board is four layers with copper-poured ground planes for maximum shielding.
- 2) The microcontroller's address and data buses are internal to the IC, i.e. no external switching.
- 3) There is no distributed microcontroller clock line, just a crystal close to the IC.
- 4) Most of the control lines on the board switch slowly and infrequently.
- 5) There are four electrometer channels, A-D to measure radiation.

REV	DESCRIPTION		BY	DATE
DRAWN BY R.E.Karl	SUN NUCLEAR CORPORATION 425-A PINEDA CT. MELBOURNE, FL 32940 (407) 259-6862			
CHECKED BY	TITLE RF-IVD2 BLOCK DIAGRAM DIODE POD/BASE STATION			
APPROVED				
	SIZE A	DRAWING NO. 1136-BD-2		REV A0
	SCALE	NONE	SHEET 1	OF 1

Transceiver Block Diagram





TR1000

- **Designed for Short-Range Wireless Data Communications**
- **Supports RF Data Transmission Rates Up to 115.2 kbps**
- **3 V, Low Current Operation plus Sleep Mode**
- **Stable, Easy to Use, Low External Parts Count**

The TR1000 hybrid transceiver is ideal for short-range wireless data applications where robust operation, small size, low power consumption and low cost are required. The TR1000 employs RFM's amplifier-sequenced hybrid (ASH) architecture to achieve this unique blend of characteristics. All critical RF functions are contained in the hybrid, simplifying and speeding design-in. The receiver section of the TR1000 is sensitive and stable. A wide dynamic range log detector, in combination with digital AGC and a compound data slicer, provide robust performance in the presence of on-channel interference or noise. Two stages of SAW filtering provide excellent receiver out-of-band rejection. The transmitter includes provisions for both on-off keyed (OOK) and amplitude-shift keyed (ASK) modulation. The transmitter employs SAW filtering to suppress output harmonics, facilitating compliance with FCC 15.249 and similar regulations.

916.50 MHz Hybrid Transceiver



Absolute Maximum Ratings

Rating	Value	Units
Power Supply and All Input/Output Pins	-0.3 to +4.0	V
Non-Operating Case Temperature	-50 to +100	°C
Soldering Temperature (10 seconds)	230	°C

Electrical Characteristics, 2.4 kbps On-Off Keyed, Low-Current RX Mode

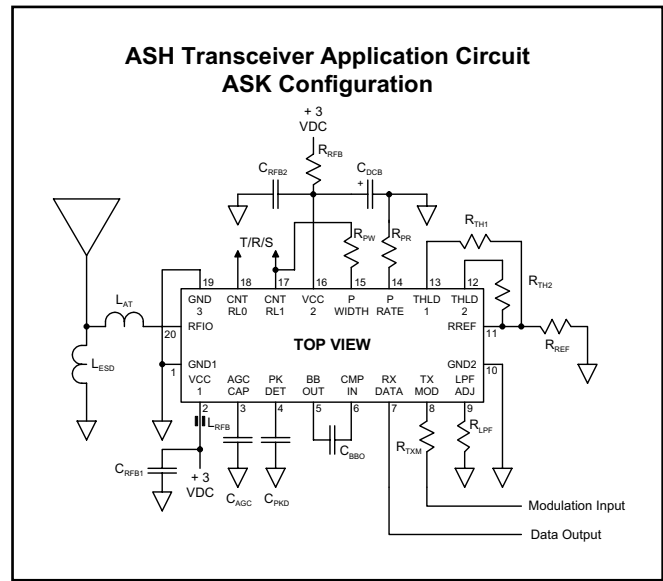
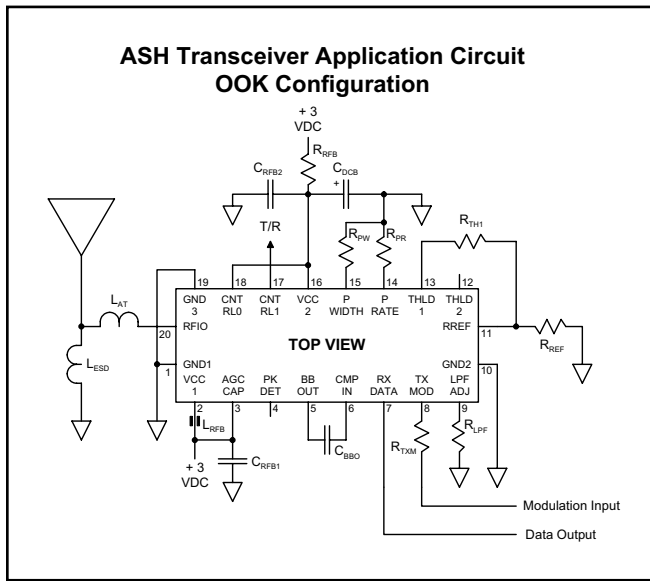
Characteristic	Sym	Notes	Minimum	Typical	Maximum	Units
Operating Frequency	f_o		916.30		916.70	MHz
Modulation Type			OOK			
Data Rate				2.4		kbps
Receiver Performance (OOK @ 2.4 kbps)						
Input Current, 3 Vdc Supply	I_R				1.8	mA
Input Signal for 10^{-4} BER, 25 °C		1		-98		dBm
Rejection, ± 30 MHz	R_{REJ}		55			dB
Transmitter Performance (OOK @ 2.4 kbps)						
Peak Input Current, 3 Vdc Supply	I_{TP}				12	mA
Peak Output Power	P_O			0.75		mW
Turn On/Turn Off Time	t_{ON}/t_{OFF}				12/6	μs
Sleep to Receive Switch Time (100 ms sleep, -85 dBm signal)	t_{SR}	3		200		μs
Sleep Mode Current	I_S				5	μA
Transmit to Receive Switch Time (100 ms transmit, -85 dBm signal)	t_{TOR}	3		200		μs
Receive to Transmit Switch Time	t_{RTO}				12	μs
Power Supply Voltage Range	V_{CC}		2.7		3.5	Vdc
Operating Ambient Temperature	T_A		-40		+85	°C

Electrical Characteristics, 19.2 kbps On-Off Keyed, High-Sensitivity RX Mode

Characteristic	Sym	Notes	Minimum	Typical	Maximum	Units
Operating Frequency	f_o		916.30		916.70	MHz
Modulation Type			OOK			
Data Rate				19.2		kbps
Receiver Performance (OOK @ 19.2 kbps)						
Input Current, 3 Vdc Supply	I_R				4.5	mA
Input Signal for 10^{-4} BER, 25 °C		1		-95		dBm
Rejection, ± 30 MHz	R_{REJ}		55			dB
Transmitter Performance (OOK @ 19.2 kbps)						
Peak Input Current, 3 Vdc Supply	I_{TP}				12	mA
Peak Output Power	P_O			0.75		mW
Turn On/Turn Off Time	t_{ON}/t_{OFF}				12/6	μs
Sleep to Receive Switch Time (90 ms sleep, -80 dBm signal)	t_{SR}	3		20		μs
Sleep Mode Current	I_S				5	μA
Transmit to Receive Switch Time (90 ms transmit, -80 dBm signal)	t_{TOR}	3		20		μs
Receive to Transmit Switch Time	t_{RTO}				12	μs
Power Supply Voltage Range	V_{CC}		2.7		3.5	Vdc
Operating Ambient Temperature	T_A		-40		+85	°C

Electrical Characteristics, 115.2 kbps Amplitude-Shift Keyed, High-Sensitivity RX Mode

Characteristic	Sym	Notes	Minimum	Typical	Maximum	Units
Operating Frequency	f_o		916.30		916.70	MHz
Modulation Type			ASK			
Data Rate				115.2		kbps
Receiver Performance (ASK @ 115.2 kbps)						
Input Current, 3 Vdc Supply	I_R				4.8	mA
Input Signal for 10^{-4} BER, 25 °C		2		-85		dBm
Rejection, ± 30 MHz	R_{REJ}		55			dB
Transmitter Performance (ASK @ 115.2 kbps)						
Peak Input Current, 3 Vdc Supply	I_{TP}				12	mA
Peak Output Power	P_O			0.75		mW
Output Rise/Fall Time	t_{TR}/t_{TF}				1.1/1.1	μs
Sleep to Receive Switch Time (15 ms sleep, -76 dBm signal)	t_{SR}	3		20		μs
Sleep Mode Current	I_S				5	μA
Transmit to Receive Switch Time (15 ms transmit, -76 dBm signal)	t_{TAR}	3		20		μs
Receive to Transmit Switch Time	t_{RTA}				12	μs
Power Supply Voltage Range	V_{CC}		2.7		3.5	Vdc
Operating Ambient Temperature	T_A		-40		+85	°C



Transceiver Set-Up, 3.0 Vdc, -40 to +85 °C

Item	Symbol	OOK	OOK	ASK	Units	Notes
Nominal NRZ Data Rate	DR _{NOM}	2.4	19.2	115.2	kbps	see pages 1 & 2
Minimum Signal Pulse	SP _{MIN}	416.67	52.08	8.68	μs	single bit
Maximum Signal Pulse	SP _{MAX}	1666.68	208.32	34.72	μs	4 bits of same value
AGCCAP Capacitor	C _{AGC}	-	-	2200	pF	±10% ceramic
PKDET Capacitor	C _{PKD}	-	-	0.001	μF	±10% ceramic
BBOUT Capacitor	C _{BBO}	0.1	0.015	0.0027	μF	±10% ceramic
TXMOD Resistor	R _{TXM}	8.2	8.2	8.2	K	±5%, for 0.25 mW output
LPFADJ Resistor	R _{LPF}	240	30	12	K	±5%
RREF Resistor	R _{REF}	100	100	100	K	±1%
THLD2 Resistor	R _{TH2}	-	-	100	K	±1%, for 6 dB below peak
THLD1 Resistor	R _{TH1}	10	27	100	K	±1%, typical values
PRATE Resistor	R _{PR}	1100	330	160	K	±5%
PWIDTH Resistor	R _{PW}	270 to GND	270 to GND	1000 to Vcc	K	±5%
RF Bypass Resistor	R _{RFB}	100	100	100	ohm	±5%
DC Bypass Capacitor	C _{DCB}	10	10	10	μF	tantalum
RF Bypass Capacitor 1	C _{RFB1}	27	27	27	pF	±5% NPO
RF Bypass Capacitor 2	C _{RFB2}	100	100	100	pF	±5% NPO
RF Bypass Bead	L _{RFB}	Fair-Rite	Fair-Rite	Fair-Rite	vendor	2506033017YO or equivalent
Series Tuning Inductor	L _{AT}	10	10	10	nH	50 ohm antenna
Shunt Tuning/ESD Inductor	L _{ESD}	100	100	100	nH	50 ohm antenna



CAUTION: Electrostatic Sensitive Device. Observe precautions when handling.

Notes:

- OOK BER measured with no DS1 threshold (DS2 disabled), and data encoded for DC-balance with a run length limited to 4 bit periods.
- ASK BER measured with a 25 mV DS1 threshold, DS2 threshold 6 dB below peak, and data encoded for DC-balance with a run length limited to 4 bit periods.
- Transmit/sleep to receive recovery time is for the period and signal level indicated, -40 to 60 °C. Recovery time will increase at higher temperatures, for longer transmit/sleep intervals and lower signal levels. See the *ASH Transceiver Designer's Guide, Appendix D*.

ASH Transceiver Theory of Operation

Introduction

RFM's amplifier-sequenced hybrid (ASH) transceiver is specifically designed for short-range wireless data communication applications. The transceiver provides robust operation, very small size, low power consumption and low implementation cost. All critical RF functions are contained in the hybrid, simplifying and speeding design-in. The ASH transceiver can be readily configured to support a wide range of data rates and protocol requirements. The transceiver features excellent suppression of transmitter harmonics and virtually no RF emissions when receiving, making it easy to certify to short-range (unlicensed) radio regulations.

Amplifier-Sequenced Receiver Operation

The ASH transceiver's unique feature set is made possible by its system architecture. The heart of the transceiver is the amplifier-sequenced receiver section, which provides over 90 dB of stable RF and detector gain without any special shielding or decoupling provisions. Stability is achieved by distributing the total RF gain over *time*. This is in contrast to a superheterodyne receiver, which achieves stability by distributing total RF gain over multiple frequencies.

Figure 1 shows the basic block diagram and timing cycle for an amplifier-sequenced receiver. Note that the bias to RF amplifiers RFA1 and RFA2 are independently controlled by a pulse generator, and

that the two amplifiers are coupled by a surface acoustic wave (SAW) delay line, which has a typical delay of 0.5 μ s.

An incoming RF signal is first filtered by a narrow-band SAW filter, and is then applied to RFA1. The pulse generator turns RFA1 ON for 0.5 μ s. The amplified signal from RFA1 emerges from the SAW delay line at the input to RFA2. RFA1 is now switched OFF and RFA2 is switched ON for 0.55 μ s, amplifying the RF signal further. The ON time for RFA2 is usually set at 1.1 times the ON time for RFA1, as the filtering effect of the SAW delay line stretches the signal pulse from RFA1 somewhat. As shown in the timing diagram, RFA1 and RFA2 are never on at the same time, assuring excellent receiver stability. Note that the narrow-band SAW filter eliminates sampling sideband responses outside of the receiver passband, and the SAW filter and delay line act together to provide very high receiver ultimate rejection.

Amplifier-sequenced receiver operation has several interesting characteristics that can be exploited in system design. The RF amplifiers in an amplifier-sequenced receiver can be turned on and off almost instantly, allowing for very quick power-down (sleep) and wake-up times. Also, both RF amplifiers can be off between ON sequences to trade-off receiver noise figure for lower average current consumption. The effect on noise figure can be modeled as if RFA1 is on continuously, with an attenuator placed in front of it with a loss equivalent to $10 \cdot \log_{10}(\text{RFA1 duty factor})$, where the duty factor is the average amount of time RFA1 is ON (up to 50%). Since an amplifier-sequenced receiver is inherently a sampling receiver, the overall cycle time between the start of one RFA1 ON sequence and

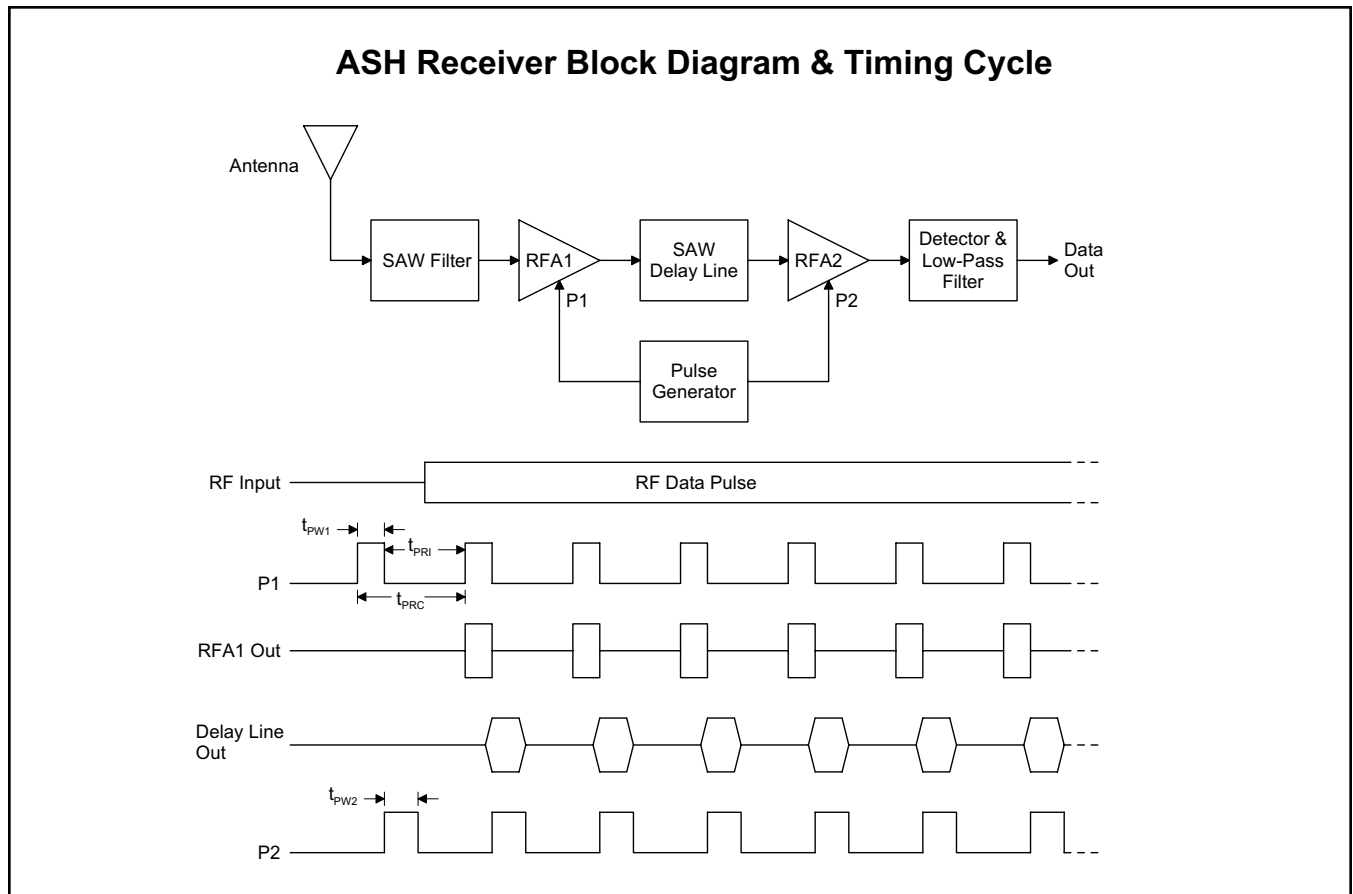


Figure 1

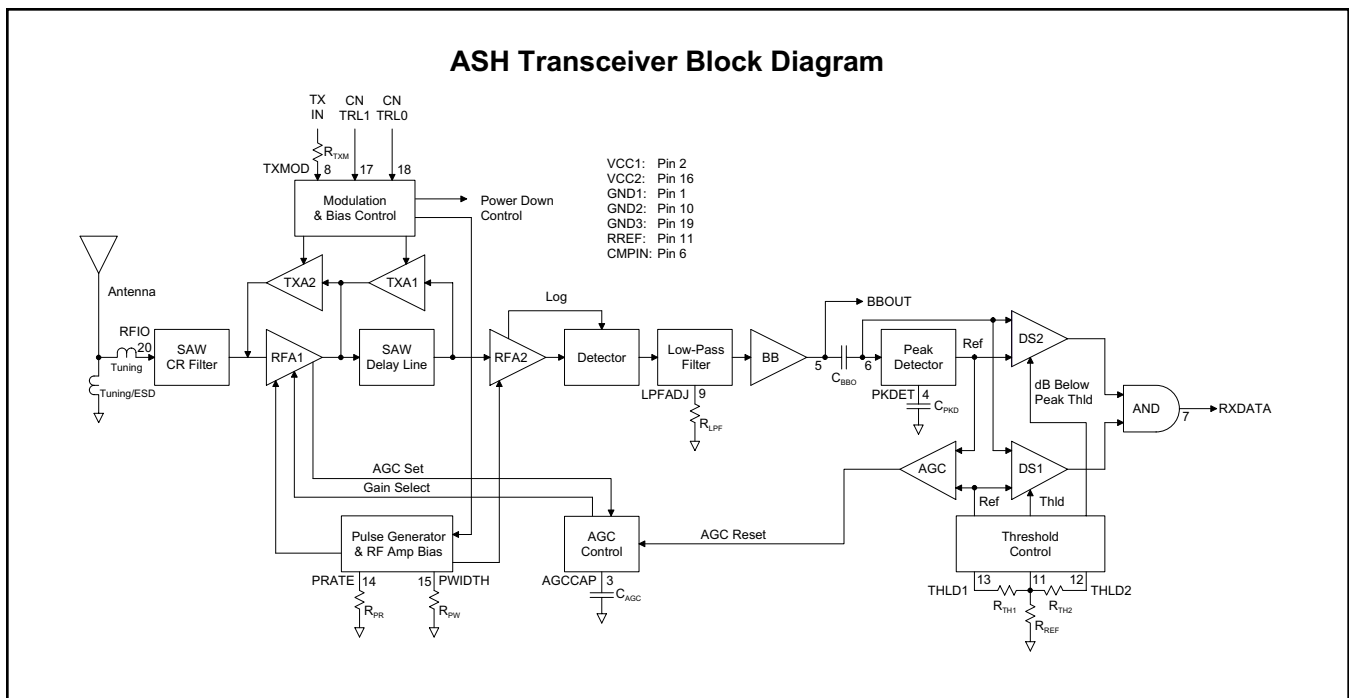


Figure 2

the start of the next RFA1 ON sequence should be set to sample the narrowest RF data pulse at least 10 times. Otherwise, significant edge jitter will be added to the detected data pulse.

ASH Transceiver Block Diagram

Figure 2 is the general block diagram of the ASH transceiver. Please refer to Figure 2 for the following discussions.

Antenna Port

The only external RF components needed for the transceiver are the antenna and its matching components. Antennas presenting an impedance in the range of 35 to 72 ohms resistive can be satisfactorily matched to the RFIO pin with a series matching coil and a shunt matching/ESD protection coil. Other antenna impedances can be matched using two or three components. For some impedances, two inductors and capacitor will be required. A DC path from RFIO to ground is required for ESD protection.

Receiver Chain

The output of the SAW filter drives amplifier RFA1. This amplifier includes provisions for detecting the onset of saturation (AGC Set), and for switching between 35 dB of gain and 5 dB of gain (Gain Select). AGC Set is an input to the AGC Control function, and Gain Select is the AGC Control function output. ON/OFF control to RFA1 (and RFA2) is generated by the Pulse Generator & RF Amp Bias function. The output of RFA1 drives the SAW delay line, which has a nominal delay of 0.5 μ s.

The second amplifier, RFA2, provides 51 dB of gain below saturation. The output of RFA2 drives a full-wave detector with 19 dB of threshold gain. The onset of saturation in each section of RFA2 is detected and summed to provide a logarithmic response. This is added to the output of the full-wave detector to produce an overall detector response that is square law for low signal levels, and transitions into a log response for high signal levels. This combination provides excellent threshold sensitivity and more than 70 dB of detector dynamic range. In combination with the 30 dB of AGC

range in RFA1, more than 100 dB of receiver dynamic range is achieved.

The detector output drives a gyrator filter. The filter provides a three-pole, 0.05 degree equiripple low-pass response with excellent group delay flatness and minimal pulse ringing. The 3 dB bandwidth of the filter can be set from 4.5 kHz to 1.8 MHz with an external resistor.

The filter is followed by a base-band amplifier which boosts the detected signal to the BBOOUT pin. When the receiver RF amplifiers are operating at a 50%-50% duty cycle, the BBOOUT signal changes about 10 mV/dB, with a peak-to-peak signal level of up to 685 mV. For lower duty cycles, the mV/dB slope and peak-to-peak signal level are proportionately less. The detected signal is riding on a 1.1 Vdc level that varies somewhat with supply voltage, temperature, etc. BBOOUT is coupled to the CMPIN pin or to an external data recovery process (DSP, etc.) by a series capacitor. The correct value of the series capacitor depends on data rate, data run length, and other factors as discussed in the *ASH Transceiver Designer's Guide*.

When an external data recovery process is used with AGC, BBOOUT must be coupled to the external data recovery process and CMPIN by separate series coupling capacitors. The AGC reset function is driven by the signal applied to CMPIN.

When the transceiver is placed in power-down (sleep) or in a transmit mode, the output impedance of BBOOUT becomes very high. This feature helps preserve the charge on the coupling capacitor to minimize data slicer stabilization time when the transceiver switches back to the receive mode.

Data Slicers

The CMPIN pin drives two data slicers, which convert the analog signal from BBOOUT back into a digital stream. The best data slicer choice depends on the system operating parameters. Data slicer DS1 is a capacitively-coupled comparator with provisions for an adjustable threshold. DS1 provides the best performance at low

signal-to-noise conditions. The threshold, or squelch, offsets the comparator's slicing level from 0 to 90 mV, and is set with a resistor between the RREF and THLD1 pins. This threshold allows a trade-off between receiver sensitivity and output noise density in the no-signal condition. For best sensitivity, the threshold is set to 0. In this case, noise is output continuously when no signal is present. This, in turn, requires the circuit being driven by the RXDATA pin to be able to process noise (and signals) continuously.

This can be a problem if RXDATA is driving a circuit that must "sleep" when data is not present to conserve power, or when it is necessary to minimize false interrupts to a multitasking processor. In this case, noise can be greatly reduced by increasing the threshold level, but at the expense of sensitivity. The best 3 dB bandwidth for the low-pass filter is also affected by the threshold level setting of DS1. The bandwidth must be increased as the threshold is increased to minimize data pulse-width variations with signal amplitude.

Data slicer DS2 can overcome this compromise once the signal level is high enough to enable its operation. DS2 is a "dB-below-peak" slicer. The peak detector charges rapidly to the peak value of each data pulse, and decays slowly in between data pulses (1:1000 ratio). The slicer trip point can be set from 0 to 120 mV below this peak value with a resistor between RREF and THLD2. A threshold of 60 mV is the most common setting, which equates to "6 dB below peak" when RFA1 and RFA2 are running a 50%-50% duty cycle. Slicing at the "6 dB-below-peak" point reduces the signal amplitude to data pulse-width variation, allowing a lower 3 dB filter bandwidth to be used for improved sensitivity.

DS2 is best for ASK modulation where the transmitted waveform has been shaped to minimize signal bandwidth. However, DS2 is subject to being temporarily "blinded" by strong noise pulses, which can cause burst data errors. Note that DS1 is active when DS2 is used, as RXDATA is the logical AND of the DS1 and DS2 outputs. DS2 can be disabled by leaving THLD2 disconnected. A non-zero DS1 threshold is required for proper AGC operation.

AGC Control

The output of the Peak Detector also provides an AGC Reset signal to the AGC Control function through the AGC comparator. The purpose of the AGC function is to extend the dynamic range of the receiver, so that two transceivers can operate close together when running ASK and/or high data rate modulation. The onset of saturation in the output stage of RFA1 is detected and generates the AGC Set signal to the AGC Control function. The AGC Control function then selects the 5 dB gain mode for RFA1. The AGC Comparator will send a reset signal when the Peak Detector output (multiplied by 0.8) falls below the threshold voltage for DS1.

A capacitor at the AGCCAP pin avoids AGC "chattering" during the time the signal propagates through the log detector, low-pass filter and charges the peak detector. The AGC capacitor also allows the hold-in time to be set longer than the peak detector decay time to avoid AGC chattering during runs of "0" bits in the received data stream. Note that AGC operation requires the peak detector to be functioning, even if DS2 is not being used. AGC operation can be defeated by connecting the AGCCAP pin to Vcc. The AGC can be latched on once engaged by connecting a 150 kilohm resistor between the AGCCAP pin and ground in lieu of a capacitor.

Receiver Pulse Generator and RF Amplifier Bias

The receiver amplifier-sequence operation is controlled by the Pulse Generator & RF Amplifier Bias module, which in turn is controlled by

the PRATE and PWIDTH input pins, and the Power Down (sleep) Control Signal from the Modulation & Bias Control function.

In the low data rate mode, the interval between the falling edge of one RFA1 ON pulse to the rising edge of the next RFA1 ON pulse t_{PRI} is set by a resistor between the PRATE pin and ground. The interval can be adjusted between 0.1 and 5 μ s. In the high data rate mode (selected at the PWIDTH pin) the receiver RF amplifiers operate at a nominal 50%-50% duty cycle. In this case, the start-to-start period t_{PRC} for ON pulses to RFA1 are controlled by the PRATE resistor over a range of 0.1 to 1.1 μ s.

In the low data rate mode, the PWIDTH pin sets the width of the ON pulse t_{PW1} to RFA1 with a resistor to ground (the ON pulse width t_{PW2} to RFA2 is set at 1.1 times the pulse width to RFA1 in the low data rate mode). The ON pulse width t_{PW1} can be adjusted between 0.55 and 1 μ s. However, when the PWIDTH pin is connected to Vcc through a 1 M resistor, the RF amplifiers operate at a nominal 50%-50% duty cycle, facilitating high data rate operation. In this case, the RF amplifiers are controlled by the PRATE resistor as described above.

Both receiver RF amplifiers are turned off by the Power Down Control Signal, which is invoked in the sleep and transmit modes.

Transmitter Chain

The transmitter chain consists of a SAW delay line oscillator followed by a modulated buffer amplifier. The SAW filter suppresses transmitter harmonics to the antenna. Note that the same SAW devices used in the amplifier-sequenced receiver are reused in the transmit modes.

Transmitter operation supports two modulation formats, on-off keyed (OOK) modulation, and amplitude-shift keyed (ASK) modulation. When OOK modulation is chosen, the transmitter output turns completely off between "1" data pulses. When ASK modulation is chosen, a "1" pulse is represented by a higher transmitted power level, and a "0" is represented by a lower transmitted power level. OOK modulation provides compatibility with first-generation ASH technology, and provides for power conservation. ASK modulation must be used for high data rates (data pulses less than 30 μ s). ASK modulation also reduces the effects of some types of interference and allows the transmitted pulses to be shaped to control modulation bandwidth.

The modulation format is chosen by the state of the CNTRL0 and the CNTRL1 mode control pins, as discussed below. When either modulation format is chosen, the receiver RF amplifiers are turned off. In the OOK mode, the delay line oscillator amplifier TXA1 and buffer amplifier TXA2 are turned off when the voltage to the TXMOD input falls below 220 mV. In the OOK mode, the data rate is limited by the turn-on and turn-off times of the delay line oscillator, which are 12 and 6 μ s respectively. In the ASK mode TXA1 is biased ON continuously, and the output of TXA2 is modulated by the TXMOD input current. Minimum output power occurs in the ASK mode when the modulation driver sinks about 10 μ A of current from the TXMOD pin.

The transmitter RF output power is proportional to the input current to the TXMOD pin. A series resistor is used to adjust the peak transmitter output power. Maximum saturated output power requires 450 μ A of input current.

Transceiver Mode Control

The four transceiver operating modes – receive, transmit ASK, transmit OOK, and power-down (sleep), are controlled by the Modulation & Bias Control function, and are selected with the CNTRL1

and CNTRL0 control pins. Setting CNTRL1 and CNTRL0 both high place the unit in the receive mode. Setting CNTRL1 high and CNTRL0 low place the unit in the ASK transmit mode. Setting CNTRL1 low and CNTRL0 high place the unit in the OOK transmit mode. Setting CNTRL1 and CNTRL0 both low place the unit in the power-down (sleep) mode. Note that the resistor driving TXMOD must be low in the receive and power-down modes. The PWIDTH resistor must also be low in the power down mode to minimize current. CNTRL1 and CNTRL0 are CMOS compatible inputs. These inputs must be held at a logic level; they cannot be left unconnected. The voltage to these pins should rise with the power supply voltage at turn on.

Transceiver Event Timing

Transceiver event timing is summarized in Table 1. Please refer to this table for the following discussions.

Turn-On Timing

The maximum time t_{PR} required for the receive function to become operational at turn on is influenced by two factors. All receiver circuitry will be operational 5 ms after the supply voltage reaches 2.7 Vdc. The BBOUT-CMPIN coupling-capacitor is then DC stabilized in 3 time constants ($3 \cdot t_{BBC}$). The total turn-on time to stable receiver operation for a 10 ms power supply rise time is:

$$t_{PR} = 15 \text{ ms} + 3 \cdot t_{BBC}$$

The maximum time required for either the OOK or ASK transmitter mode to become operational is 5 ms after the supply voltage reaches 2.7 Vdc (switch from receive mode). The transceiver should be turned on in the receive mode until the supply voltage reaches 2.7 Vdc. Thereafter, any mode may be selected.

Receive-to-Transmit Timing

After turn on, the maximum time required to switch from receive to either transmit mode is 12 μ s. Most of this time is due to the start-up of the transmitter oscillator.

Transmit-to-Receive Timing

The maximum time required to switch from the OOK or ASK transmit mode to the receive mode is $3 \cdot t_{BBC}$, where t_{BBC} is the BBOUT-CMPIN coupling-capacitor time constant. When the operating temperature is limited to 70 °C, the time required to switch from transmit to receive is dramatically less for short transmissions, as less charge leaks away from the BBOUT-CMPIN coupling capacitor.

Sleep and Wake-Up Timing

The maximum transition time from the receive mode to the power-down (sleep) mode t_{RS} is 10 μ s after CNTRL1 and CNTRL0 are both low (1 μ s fall time).

The maximum transition time from either transmit mode to the sleep mode (t_{TOS} and t_{TAS}) is 10 μ s after CNTRL1 and CNTRL0 are both low (1 μ s fall time).

The maximum transition time t_{SR} from the sleep mode to the receive mode is $3 \cdot t_{BBC}$, where t_{BBC} is the BBOUT-CMPIN coupling-capacitor time constant. When the operating temperature is limited to 60 °C, the time required to switch from sleep to receive is dramatically less

for short sleep times, as less charge leaks away from the BBOUT-CMPIN coupling capacitor.

The maximum time required to switch from the sleep mode to either transmit mode (t_{STO} and t_{STA}) is 16 μ s. Most of this time is due to the start-up of the transmitter oscillator.

AGC Timing

The maximum AGC engage time t_{AGC} is 5 μ s after the reception of a -30 dBm RF signal with a 1 μ s envelope rise time.

The minimum AGC hold-in time is set by the value of the capacitor at the AGCCAP pin. The hold-in time $t_{AGH} = C_{AGC}/19.1$, where t_{AGH} is in μ s and C_{AGC} is in pF.

Peak Detector Timing

The Peak Detector attack time constant is set by the value of the capacitor at the PKDET pin. The attack time $t_{PKA} = C_{PKD}/4167$, where t_{PKA} is in μ s and C_{PKD} is in pF. The Peak Detector decay time constant $t_{PKD} = 1000 \cdot t_{PKA}$.

Pulse Generator Timing

In the low data rate mode, the interval t_{PRI} between the falling edge of an ON pulse to the first RF amplifier and the rising edge of the next ON pulse to the first RF amplifier is set by a resistor R_{PR} between the PRATE pin and ground. The interval can be adjusted between 0.1 and 5 μ s with a resistor in the range of 51 K to 2000 K. The value of the R_{PR} is given by:

$$R_{PR} = 404 \cdot t_{PRI} + 10.5, \text{ where } t_{PRI} \text{ is in } \mu\text{s, and } R_{PR} \text{ is in kilohms}$$

In the high data rate mode (selected at the PWIDTH pin) the receiver RF amplifiers operate at a nominal 50%-50% duty cycle. In this case, the period t_{PRC} from the start of an ON pulse to the first RF amplifier to the start of the next ON pulse to the first RF amplifier is controlled by the PRATE resistor over a range of 0.1 to 1.1 μ s using a resistor of 11 K to 220 K. In this case R_{PR} is given by:

$$R_{PR} = 198 \cdot t_{PRC} - 8.51, \text{ where } t_{PRC} \text{ is in } \mu\text{s and } R_{PR} \text{ is in kilohms}$$

In the low data rate mode, the PWIDTH pin sets the width of the ON pulse to the first RF amplifier t_{PW1} with a resistor R_{PW} to ground (the ON pulse width to the second RF amplifier t_{PW2} is set at 1.1 times the pulse width to the first RF amplifier in the low data rate mode). The ON pulse width t_{PW1} can be adjusted between 0.55 and 1 μ s with a resistor value in the range of 200 K to 390 K. The value of R_{PW} is given by:

$$R_{PW} = 404 \cdot t_{PW1} - 18.6, \text{ where } t_{PW1} \text{ is in } \mu\text{s and } R_{PW} \text{ is in kilohms}$$

However, when the PWIDTH pin is connected to Vcc through a 1 M resistor, the RF amplifiers operate at a nominal 50%-50% duty cycle, facilitating high data rate operation. In this case, the RF amplifiers are controlled by the PRATE resistor as described above.

LPF Group Delay

The low-pass filter group delay is a function of the filter 3 dB bandwidth, which is set by a resistor R_{LPF} to ground at the LPFADJ pin. The minimum 3 dB bandwidth $f_{LPF} = 1445/R_{LPF}$, where f_{LPF} is in kHz, and R_{LPF} is in kilohms.

The maximum group delay $t_{FGD} = 1750/f_{LPF} = 1.21 \cdot R_{LPF}$, where t_{FGD} is in μ s, f_{LPF} in kHz, and R_{LPF} in kilohms.

Transceiver Event Timing, 3.0 Vdc, -40 to +85 °C

Event	Symbol	Time	Min/Max	Test Conditions	Notes
Turn On to Receive	t_{PR}	$3 \cdot t_{BBC} + 15 \text{ ms}$	max	10 ms supply voltage rise time	time until receiver operational
Turn On to TXOOK	t_{PTO}	15 ms	max	10 ms supply voltage rise time	time until TXMOD can modulate transmitter
Turn On to TXASK	t_{PTA}	15 ms	max	10 ms supply voltage rise time	time until TXMOD can modulate transmitter
RX to TXOOK	t_{RTO}	12 μs	max	1 μs CNTRL1 fall time	TXMOD low 1 μs before CNTRL1 falls
RX to TXASK	t_{RTA}	12 μs	max	1 μs CNTRL0 fall time	TXMOD low 1 μs before CNTRL0 falls
TXOOK to RX	t_{TOR}	$3 \cdot t_{BBC}$	max	1 μs CNTRL1 rise time	time until receiver operational
TXASK to RX	t_{TAR}	$3 \cdot t_{BBC}$	max	1 μs CNTRL0 rise time	time until receiver operational
Sleep to RX	t_{SR}	$3 \cdot t_{BBC}$	max	1 μs CNTRL0/CNTRL1 rise times	time until receiver operational
Sleep to TXOOK	t_{STO}	16 μs	max	1 μs CNTRL0 rise time	time until TXMOD can modulate transmitter
Sleep to TXASK	t_{STA}	16 μs	max	1 μs CNTRL1 rise time	time until TXMOD can modulate transmitter
RX to Sleep	t_{RS}	10 μs	max	1 μs CNTRL0/CNTRL1 fall times	time until transceiver is in power-down mode
TXOOK to Sleep	t_{TOS}	10 μs	max	1 μs CNTRL0 fall time	time until transceiver is in power-down mode
TXASK to Sleep	t_{TAS}	10 μs	max	1 μs CNTRL1 fall time	time until transceiver is in power-down mode
AGC Engage	t_{AGC}	5 μs	max	1 μs rise time, -30 dBm signal	RFA1 switches from 35 to 5 dB gain
AGC Hold-In	t_{AGH}	$C_{AGC}/19.1$	min	CAGC in pF, t_{AGH} in μs	user selected; longer than t_{PKD}
PKDET Attack Time Constant	t_{PKA}	$C_{PKD}/4167$	min	C_{PKD} in pF, t_{PKA} in μs	user selected
PKDET Decay Time Constant	t_{PKD}	$1000 \cdot t_{PKA}$	min	t_{PKD} and t_{PKA} in μs	slaved to attack time
PRATE Interval	t_{PRI}	0.1 to 5 μs	range	low data rate mode	user selected mode
PWIDTH RFA1	t_{PW1}	0.55 to 1 μs	range	low data rate mode	user selected mode
PWIDTH RFA2	t_{PW2}	$1.1 \cdot t_{PW1}$	range	low data rate mode	user selected mode
PRATE Cycle	t_{PRC}	0.1 to 1.1 μs	range	high data rate mode	user selected mode
PWIDTH High (RFA1 & RFA2)	t_{PWH}	0.05 to 0.55 μs	range	high data rate mode	user selected mode
LPF Group Delay	t_{GD}	$1750/f_{LPF}$	max	t_{GD} in μs , f_{LPF} in kHz	user selected
LPF 3 dB Bandwidth	f_{LPF}	$1445/R_{LPF}$	min	f_{LPF} in kHz, R_{LPF} in kilohms	user selected
BBOUT-CMPIN Time Constant	t_{BBC}	$0.064 \cdot C_{BBO}$	min	t_{BBC} in μs , C_{BBO} in pF	user selected

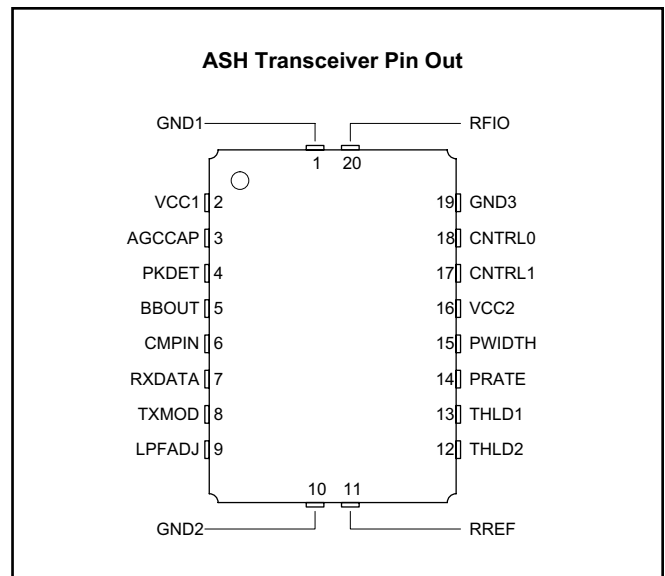
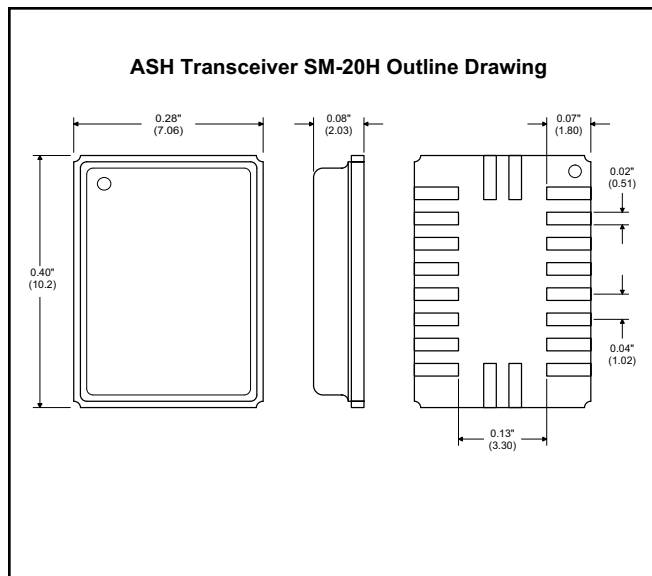
Table 1

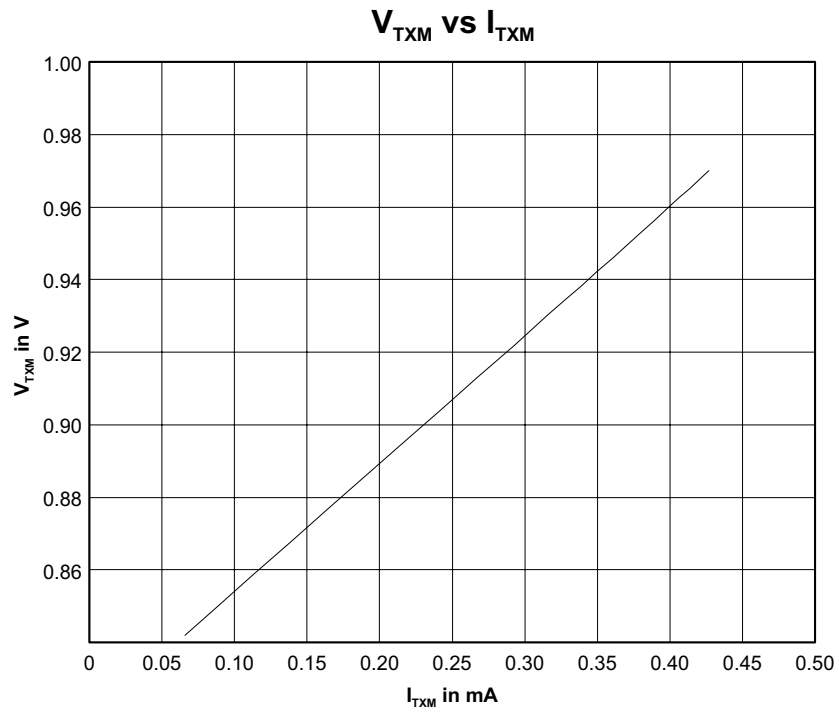
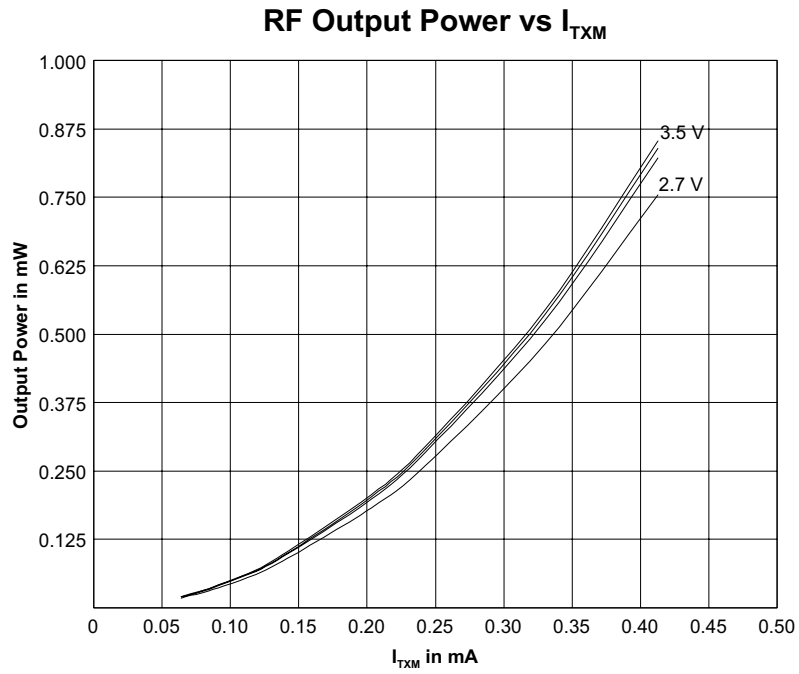
Pin Descriptions

Pin	Name	Description
1	GND1	GND1 is a transceiver RF ground pin. This pin should be connected to GND3 by a direct, low-inductance trace.
2	VCC1	VCC1 is the positive supply voltage pin for the transmitter output amplifier and the receiver base-band circuitry. VCC1 must be connected to the positive supply through a ferrite RF decoupling bead which is bypassed by an RF capacitor on the <i>supply side</i> . See the description of VCC2 (Pin 16) for additional information.
3	AGCCAP	This pin controls the AGC reset operation. A capacitor between this pin and ground sets the minimum time the AGC will hold-in once it is engaged. The hold-in time is set to avoid AGC chattering. For a given hold-in time t_{AGH}, the capacitor value C_{AGC} is: $C_{AGC} = 19.1 * t_{AGH}, \text{ where } t_{AGH} \text{ is in } \mu\text{s and } C_{AGC} \text{ is in pF}$ A $\pm 10\%$ ceramic capacitor should be used at this pin. The value of C_{AGC} given above provides a hold-in time between t_{AGH} and $2.65 * t_{AGH}$, depending on operating voltage, temperature, etc. The hold-in time is chosen to allow the AGC to ride through the longest run of zero bits that can occur in a received data stream. The AGC hold-in time can be greater than the peak detector decay time, as discussed below. However, the AGC hold-in time should not be set too long, or the receiver will be slow in returning to full sensitivity once the AGC is engaged by noise or interference. The use of AGC is optional when using OOK modulation with data pulses of at least 30 μs. AGC operation can be defeated by connecting this pin to Vcc. Active or latched AGC operation is required for ASK modulation and/or for data pulses of less than 30 μs. The AGC can be latched on once engaged by connecting a 150 K resistor between this pin and ground, instead of a capacitor. AGC operation depends on a functioning peak detector, as discussed below. The AGC capacitor is discharged in the receiver power-down (sleep) mode and in the transmit modes.
4	PKDET	This pin controls the peak detector operation. A capacitor between this pin and ground sets the peak detector attack and decay times, which have a fixed 1:1000 ratio. For most applications, these time constants should be coordinated with the base-band time constant. For a given base-band capacitor C_{BBO}, the capacitor value C_{PKD} is: $C_{PKD} = 0.33 * C_{BBO}, \text{ where } C_{BBO} \text{ and } C_{PKD} \text{ are in pF}$ A $\pm 10\%$ ceramic capacitor should be used at this pin. This time constant will vary between t_{PKA} and $1.5 * t_{PKA}$ with variations in supply voltage, temperature, etc. The capacitor is driven from a 200 ohm "attack" source, and decays through a 200 K load. The peak detector is used to drive the "dB-below-peak" data slicer and the AGC release function. The AGC hold-in time can be extended beyond the peak detector decay time with the AGC capacitor, as discussed above. Where low data rates and OOK modulation are used, the "dB-below-peak" data slicer and the AGC are optional. In this case, the PKDET pin and the THLD2 pin can be left unconnected, and the AGC pin can be connected to Vcc to reduce the number of external components needed. The peak detector capacitor is discharged in the receiver power-down (sleep) mode and in the transmit modes.
5	BBOUT	BBOUT is the receiver base-band output pin. This pin drives the CMPIN pin through a coupling capacitor C_{BBO} for internal data slicer operation. The time constant t_{BBC} for this connection is: $t_{BBC} = 0.064 * C_{BBO}, \text{ where } t_{BBC} \text{ is in } \mu\text{s and } C_{BBO} \text{ is in pF}$ A $\pm 10\%$ ceramic capacitor should be used between BBOUT and CMPIN. The time constant can vary between t_{BBC} and $1.8 * t_{BBC}$ with variations in supply voltage, temperature, etc. The optimum time constant in a given circumstance will depend on the data rate, data run length, and other factors as discussed in the <i>ASH Transceiver Designer's Guide</i>. A common criteria is to set the time constant for no more than a 20% voltage droop during SP_{MAX}. For this case: $C_{BBO} = 70 * SP_{MAX}, \text{ where } SP_{MAX} \text{ is the maximum signal pulse width in } \mu\text{s and } C_{BBO} \text{ is in pF}$ The output from this pin can also be used to drive an external data recovery process (DSP, etc.). The nominal output impedance of this pin is 1 K. When the receiver RF amplifiers are operating at a 50%-50% duty cycle, the BBOUT signal changes about 10 mV/dB, with a peak-to-peak signal level of up to 685 mV. For lower duty cycles, the mV/dB slope and peak-to-peak signal level are proportionately less. The signal at BBOUT is riding on a 1.1 Vdc value that varies somewhat with supply voltage and temperature, so it should be coupled through a capacitor to an external load. A load impedance of 50 K to 500 K in parallel with no more than 10 pF is recommended. When an external data recovery process is used with AGC, BBOUT must be coupled to the external data recovery process and CMPIN by separate series coupling capacitors. The AGC reset function is driven by the signal applied to CMPIN. When the transceiver is in power-down (sleep) or in a transmit mode, the output impedance of this pin becomes very high, preserving the charge on the coupling capacitor.
6	CMPIN	This pin is the input to the internal data slicers. It is driven from BBOUT through a coupling capacitor. The input impedance of this pin is 70 K to 100 K.
7	RXDATA	RXDATA is the receiver data output pin. This pin will drive a 10 pF, 500 K parallel load. The peak current available from this pin increases with the receiver low-pass filter cutoff frequency. In the power-down (sleep) or transmit modes, this pin becomes high impedance. If required, a 1000 K pull-up or pull-down resistor can be used to establish a definite logic state when this pin is high impedance. If a pull-up resistor is used, the positive supply end should be connected to a voltage no greater than $V_{cc} + 200 \text{ mV}$.

Pin	Name	Description
8	TXMOD	The transmitter RF output voltage is proportional to the input current to this pin. A series resistor is used to adjust the peak transmitter output voltage. Maximum saturated output power requires 450 μA of input current. In the ASK mode, minimum output power occurs when the modulation driver sinks about 10 μA of current from this pin. In the OOK mode, input signals less than 220 mV completely turn the transmitter oscillator off. Internally, this pin appears to be a diode in series with a small resistor. Peak transmitter output power P_O for a 3 Vdc supply voltage is approximately: $P_O = 4.8 \cdot (I_{TXM})^2$ where P_O is in mW, and the peak modulation current I_{TXM} is in mA A $\pm 5\%$ resistor is recommended. A starting point resistor value for FCC Part 15.249 applications is 8.2 K. In the OOK mode, this pin is usually driven with a logic-level data input (unshaped data pulses). OOK modulation is practical for data pulses of 30 μs or longer. In the ASK mode, this pin accepts analog modulation (shaped or unshaped data pulses). ASK modulation is practical for data pulses 8.7 μs or longer. <i>The resistor driving this pin must be low in the receive and power-down (sleep) modes. Please refer to the ASH Transceiver Designer's Guide for additional information on modulation techniques.</i>
9	LPFADJ	This pin is the receiver low-pass filter bandwidth adjust. The filter bandwidth is set by a resistor R_{LPF} between this pin and ground. The resistor value can range from 330 K to 820 ohms, providing a filter 3 dB bandwidth f_{LPF} from 4.5 kHz to 1.8 MHz. The resistor value is determined by: $R_{LPF} = 1445 / f_{LPF}$ where R_{LPF} is in kilohms, and f_{LPF} is in kHz A $\pm 5\%$ resistor should be used to set the filter bandwidth. This will provide a 3 dB filter bandwidth between f_{LPF} and $1.3 \cdot f_{LPF}$ with variations in supply voltage, temperature, etc. The filter provides a three-pole, 0.05 degree equiripple phase response. The peak drive current available from RXDATA increases in proportion to the filter bandwidth setting.
10	GND2	GND2 is the ground return pin for the receiver base-band circuitry. It should be returned to GND1 or GND3 by a short, low inductance trace.
11	RREF	RREF is the external reference resistor pin. A 100 K reference resistor is connected between this pin and ground. A $\pm 1\%$ resistor tolerance is recommended. It is important to keep the total capacitance between ground, Vcc and this node to less than 5 pF to maintain current source stability. If THLD1 and/or THLD2 are connected to RREF through resistor values less than 1.5 K, their node capacitance must be added to the RREF node capacitance and the total should not exceed 5 pF.
12	THLD2	THLD2 is the "dB-below-peak" data slicer (DS2) threshold adjust pin. The threshold is set by a 0 to 200 K resistor R_{TH2} between this pin and RREF. Increasing the value of the resistor decreases the threshold below the peak detector value (increases difference) from 0 to 120 mV. For most applications, this threshold should be set at 6 dB below peak, or 60 mV for a 50%-50% RF amplifier duty cycle. The value of the THLD2 resistor is given by: $R_{TH2} = 1.67 \cdot V$ where R_{TH2} is in kilohms and the threshold V is in mV A $\pm 1\%$ resistor tolerance is recommended for the THLD2 resistor. Leaving the THLD2 pin open disables the dB-below-peak data slicer operation.
13	THLD1	The THLD1 pin sets the threshold for the standard data slicer (DS1) through a resistor R_{TH1} to RREF. The threshold is increased by increasing the resistor value. Connecting this pin directly to RREF provides zero threshold. The value of the resistor depends on whether THLD2 is used. For the case that THLD2 is not used, the acceptable range for the resistor is 0 to 100 K, providing a THLD1 range of 0 to 90 mV. The resistor value is given by: $R_{TH1} = 1.11 \cdot V$ where R_{TH1} is in kilohms and the threshold V is in mV For the case that THLD2 is used, the acceptable range for the THLD1 resistor is 0 to 200 K, again providing a THLD1 range of 0 to 90 mV. The resistor value is given by: $R_{TH1} = 2.22 \cdot V$ where R_{TH1} is in kilohms and the threshold V is in mV A $\pm 1\%$ resistor tolerance is recommended for the THLD1 resistor. Note that a non-zero DS1 threshold is required for proper AGC operation.
14	PRATE	The interval between the falling edge of an ON pulse to the first RF amplifier and the rising edge of the next ON pulse to the first RF amplifier t_{PRI} is set by a resistor R_{PR} between this pin and ground. The interval t_{PRI} can be adjusted between 0.1 and 5 μs with a resistor in the range of 51 K to 2000 K. The value of R_{PR} is given by: $R_{PR} = 404 \cdot t_{PRI} + 10.5$ where t_{PRI} is in μs, and R_{PR} is in kilohms A $\pm 5\%$ resistor value is recommended. When the PWIDTH pin is connected to Vcc through a 1 M resistor, the RF amplifiers operate at a nominal 50%-50% duty cycle, facilitating high data rate operation. In this case, the period t_{PRC} from start-to-start of ON pulses to the first RF amplifier is controlled by the PRATE resistor over a range of 0.1 to 1.1 μs using a resistor of 11 K to 220 K. In this case the value of R_{PR} is given by: $R_{PR} = 198 \cdot t_{PRC} - 8.51$ where t_{PRC} is in μs and R_{PR} is in kilohms A $\pm 5\%$ resistor value should also be used in this case. Please refer to the ASH Transceiver Designer's Guide for additional amplifier duty cycle information. It is important to keep the total capacitance between ground, Vcc and this pin to less than 5 pF to maintain stability.

Pin	Name	Description
15	PWIDTH	The PWIDTH pin sets the width of the ON pulse to the first RF amplifier t_{PW1} with a resistor R_{PW} to ground (the ON pulse width to the second RF amplifier t_{PW2} is set at 1.1 times the pulse width to the first RF amplifier). The ON pulse width t_{PW1} can be adjusted between 0.55 and 1 μs with a resistor value in the range of 200 K to 390 K. The value of R_{PW} is given by: $R_{PW} = 404 * t_{PW1} - 18.6$ where t_{PW1} is in μs and R_{PW} is in kilohms A $\pm 5\%$ resistor value is recommended. When this pin is connected to Vcc through a 1 M resistor, the RF amplifiers operate at a nominal 50%-50% duty cycle, facilitating high data rate operation. In this case, the RF amplifier ON times are controlled by the PRATE resistor as described above. It is important to keep the total capacitance between ground, Vcc and this node to less than 5 pF to maintain stability. When using the high data rate operation with the sleep mode, connect the 1 M resistor between this pin and CNTRL1 (Pin 17), so this pin is low in the sleep mode.
16	VCC2	VCC2 is the positive supply voltage pin for the receiver RF section and transmitter oscillator. Pin 16 must be bypassed with an RF capacitor, and isolated from the positive supply by a 100 ohm resistor. VCC2 must also be bypassed with a 10 μ F tantalum capacitor. See the description of VCC1 (Pin 2) for additional information.
17	CNTRL1	CNTRL1 and CNTRL0 select the receive and transmit modes. CNTRL1 and CNTRL0 both high place the unit in the receive mode. CNTRL1 high and CNTRL0 low place the unit in the ASK transmit mode. CNTRL1 low and CNTRL0 high place the unit in the OOK transmit mode. CNTRL1 and CNTRL0 both low place the unit in the power-down (sleep) mode. CNTRL1 is a high-impedance input (CMOS compatible). An input voltage of 0 to 200 mV is interpreted as a logic low. An input voltage of Vcc - 200 mV or greater is interpreted as a logic high. An input voltage greater than Vcc + 200 mV should not be applied to this pin. This pin must be held at a logic level; it cannot be left unconnected. At turn on, the voltage on this pin and CNTRL0 should rise with VCC until VCC reaches 2.7 Vdc (receive mode). Thereafter, any mode can be selected.
18	CNTRL0	CNTRL0 is used with CNTRL1 to control the receive and transmit modes of the transceiver. CNTRL0 is a high-impedance input (CMOS compatible). An input voltage of 0 to 200 mV is interpreted as a logic low. An input voltage of Vcc - 200 mV or greater is interpreted as a logic high. An input voltage greater than Vcc + 200 mV should not be applied to this pin. This pin must be held at a logic level; it cannot be left unconnected. At turn on, the voltage on this pin and CNTRL1 should rise with VCC until VCC reaches 2.7 Vdc (receive mode). Thereafter, any mode can be selected.
19	GND3	GND3 a transceiver RF ground pin. This pin should be connected to GND1 by a direct, low-inductance trace.
20	RFIO	RFIO is the RF input/output pin. This pin is connected directly to the SAW filter transducer. Antennas presenting an impedance in the range of 35 to 72 ohms resistive can be satisfactorily matched to this pin with a series matching coil and a shunt matching/ESD protection coil. Other antenna impedances can be matched using two or three components. For some impedances, two inductors and capacitor will be required. A DC path from RFIO to ground is required for ESD protection.





Note: Specifications subject to change without notice.